

6-17-98

FORM PTO-1595
(Rev. 6-93)
OMB No. 0651-0011 (exp. 4/94)

RE

07-01-1998

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office



To the Honorable Commissioner of Patents 100752787 attached original documents or copy thereof.

1. Name of conveying party(ies):
Yukio SAITOH; Shigenori TOSHIYOSHI; Tokitsugu ZUSHI;
Takanori NISHIMURA

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies):
Name: Komatsu Electronic Metals Co., Ltd.
Internal Address: _____

Street Address: 2612, Shinomiya, Hiratsuka-shi
Kanagawa JAPAN

City: _____ State: _____ ZIP: _____

Additional name(s) & address(es) attached? Yes No

JD542 U.S. PTO
09/098872
06/17/98

3. Nature of conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other _____

Execution Date: June 9, 1998

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: June 17, 1998

A. Patent Application No.(s) _____ B. Patent No.(s) _____

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Gerald T. Shekleton, Esq.
Internal Address: _____

Street Address: WELSH & KATZ, LTD.
120 South Riverside Plaza / 22nd Floor
City: Chicago State: Illinois ZIP: 60603-3913

6. Total number of applications and patents involved:

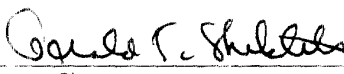
7. Total Fee (37 CFR 3.41) \$40.00
 Enclosed
 Authorized to be charged to deposit account

8. Deposit account number: _____

(Attach duplicate copy of this page if paying by deposit account)

DO NOT USE THIS SPACE

9. Statement and signature.
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Gerald T. Shekleton  June 17, 1998
Name of Person Signing Signature Date

Total number of pages including cover sheet, attachments, and document:

Mail documents to be recorded with required cover sheet information to:

06/29/1998 JMATKINS 00000065 09098872
01 FC:581 40.00 OP

Assistant Commissioner for Patents
Box Assignments
Washington, D.C. 20231

PATENT
REEL: 9269 FRAME: 0403

ASSIGNMENT

WHEREAS I/We, the below named inventor(s), [hereinafter referred to as Assignor(s)], have made an invention entitled:
A METHOD OF DETECTING CONCENTRATION OF CONTAMINATION ON A

 (Title of Invention)

SEMICONDUCTOR WAFER

for which I/We executed an application for United States Letters Patent concurrently herewith or filed an application for
 United States Letters Patent on _____, 19____ (Serial No. _____); and

WHEREAS, Komatsu Electronic Metals Co., Ltd.

 (Full Name of Assignee)

a corporation of Japan

 (Country of Incorporation)

whose post office address is 2612, Shinomiya, Hiratsuka-shi, Kanagawa, Japan

(hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention, the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/We, as assignor(s), have sold, assigned, transferred and set over and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors and assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

IN TESTIMONY WHEREOF, I/We have hereunto set our hand(s).

1. FULL NAME OF SOLE OR FIRST ASSIGNOR <u>Yukio Saitoh</u>	ASSIGNOR'S SIGNATURE <i>Yukio Saitoh</i>	DATE <u>June 9, 1998</u>
ADDRESS <u>c/o Komatsu Electronic Metals Co., Ltd., 2612, Shinomiya, Hiratsuka-shi, Kanagawa, Japan</u>	CITIZENSHIP <u>Japanese</u>	
2. FULL NAME OF SECOND ASSIGNOR, IF ANY <u>Shigenori Toshiyoshi</u>	ASSIGNOR'S SIGNATURE <i>Shigenori Toshiyoshi</i>	DATE <u>June 9, 1998</u>
ADDRESS <u>c/o Komatsu Electronic Metals Co., Ltd., 2612, Shinomiya, Hiratsuka-shi, Kanagawa, Japan</u>	CITIZENSHIP <u>Japanese</u>	
3. FULL NAME OF THIRD ASSIGNOR, IF ANY <u>Tokitsugu Zushi</u>	ASSIGNOR'S SIGNATURE <i>Tokitsugu Zushi</i>	DATE <u>June 9, 1998</u>
ADDRESS <u>c/o Komatsu Electronic Metals Co., Ltd., 2612, Shinomiya, Hiratsuka-shi, Kanagawa, Japan</u>	CITIZENSHIP <u>Japanese</u>	
4. FULL NAME OF FOURTH ASSIGNOR, IF ANY <u>Takanori Nishimura</u>	ASSIGNOR'S SIGNATURE <i>Takanori Nishimura</i>	DATE <u>June 9, 1998</u>
ADDRESS <u>c/o Komatsu Electronic Metals Co., Ltd., 2612, Shinomiya, Hiratsuka-shi, Kanagawa, Japan</u>	CITIZENSHIP <u>Japanese</u>	
5. FULL NAME OF FIFTH ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE	DATE
ADDRESS	CITIZENSHIP	
6. FULL NAME OF SIXTH ASSIGNOR, IF ANY	ASSIGNOR'S SIGNATURE	DATE
ADDRESS	CITIZENSHIP	

PATENT